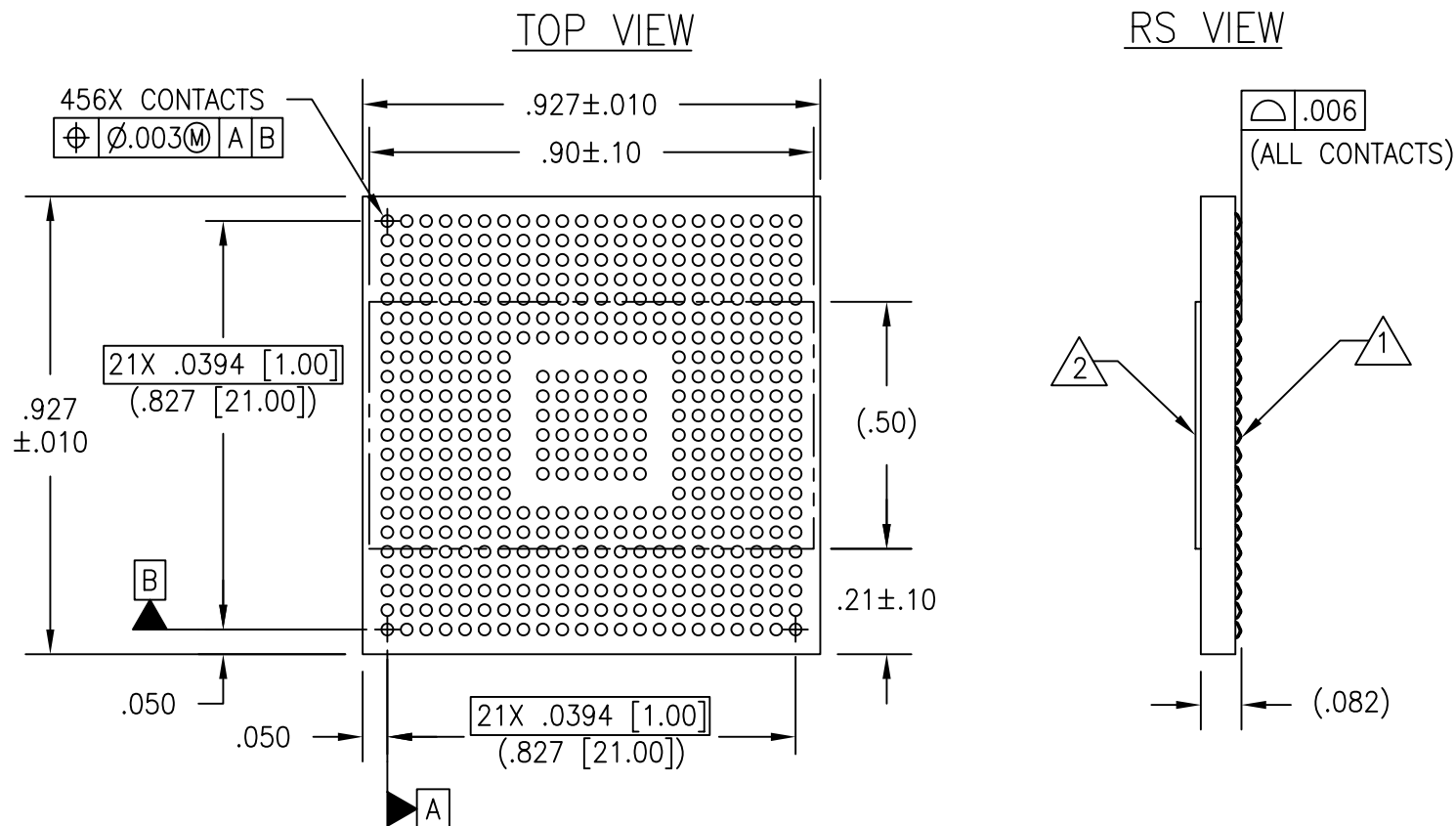


REV	DESCRIPTION	DATE	BY
A	NEW DRAWING	03/09/06	H.N.


F7729



NOTES:

1. CONTACT MATERIAL: BERYLLIUM COPPER.
CONTACT PLATING: HARD GOLD OVER NICKEL.
2. INSULATOR MATERIAL: FR4
3. KAPTON TAPE FOR PICK AND PLACE.
4. REFER TO ET HiLo APPLICATION GUIDELINES FOR LAND PATTERN, STENCIL DESIGN AND KEEP OUT ZONE RECOMMENDATIONS.

UNLESS OTHERWISE SPECIFIED:
DIMENSIONS ARE IN INCHES
TOLERANCES:
ANGLES: \pm
FRACTIONS: $\pm 1/64$
DECIMALS:
.XX $\pm .010$
.XXX $\pm .005$
.XXXX $\pm .0005$

ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE SPECIFIED			
		Emulation Technology, Inc. — VLSI and SMT ADAPTERS and ACCESSORIES —	
		2344 Walsh Avenue, Bldg.F Santa Clara, Ca 95051 TEL:(408)982-0660 FAX:(408)982-0664	
SHEET: 1 OF 1	DATE: 03/09/06	REVISION: A	ASSEMBLY DRAWING
CHECKED: Perry Munroe	DRAWN: Huy Nguyen	ITEM: HLS-220456-B-10	
Scale N/A	DO NOT SCALE DRAWING	DESCRIPTION: HLS-220456-B-10	